

---

***IN THE UNITED STATES PATENT AND TRADEMARK OFFICE***

---

In re application of: MOSTAFAZADEH et al.

Attorney Docket No.:  
NSC1P226R/P03856R1

Application No.: 10/016,750

Examiner: Jarrett J. Stark

Filed: December 10, 2001

Group: 2823

Title: LEAD FRAME DESIGN FOR  
INCREASED CHIP PINOUT

Confirmation No.: 5469

---

CERTIFICATE OF EFS-WEB TRANSMISSION

I hereby certify that this correspondence is being transmitted electronically through EFS-WEB to the Commissioner for Patents, P.O. Box 1450 Alexandria, VA 22313-1450 on September 10, 2009.

Signed: /Kathryn Throckmorton/  
Kathryn Throckmorton

**INFORMATION DISCLOSURE STATEMENT**

Mail Stop BPAI  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Dear Sir:

Enclosed is a computerized English language translation of Japanese Patent Application No. 05-121631 (the Kawakami reference) that is already of record in this case.

Accompanying this Information Disclosure Statement is the fee set forth in 37 CFR 1.17(p).

The Commissioner is hereby authorized to charge Deposit Account 50-4481 (Order No. NSC1P226R) for \$180.00 in payment of the Information Disclosure Statement Fee. If it is determined that any additional fees are due, the Commissioner is hereby authorized to charge such fees to Deposit Account 50-4481 (Order No. NSC1P226R).

Respectfully submitted,  
BEYER LAW GROUP LLP

/Steve D Beyer/  
Steve D Beyer  
Registration No. 31,234

P.O. Box 1687  
Cupertino, CA 95015-1687  
408-255-8001

